PD-91289E

International **IGR** Rectifier **POWER MOSFET THRU-HOLE (TO-257AA)**

Product Summary

Part Number	RDS(on)	ID	Eyelets	
IRFY240C	0.18 Ω	16A	Ceramic	
IRFY240CM	0.18 Ω	16A	Ceramic	

HEXFET[®] MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

Absolute Maximum Ratings

IRFY240C, IRFY240CM 200V, N-CHANNEL HEXFET[®] MOSFET TECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Ceramic Eyelets
- Ideally Suited For Space Level Applications

	Parameter		Units
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	16	
$I_D @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	10.2	A
IDM	Pulsed Drain Current ①	64	
P _D @ T _C = 25°C	Max. Power Dissipation	100	W
	Linear Derating Factor	0.8	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy 2	580	mJ
lar	Avalanche Current ①	16	Α
EAR	Repetitive Avalanche Energy ①	10	mJ
dv/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns
ТJ	Operating Junction	-55 to 150	
TSTG	Storage Temperature Range		°C
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
	Weight	4.3 (Typical)	g

For footnotes refer to the last page

IRFY240C, IRFY240CM

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Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	200	—	_	V	V _{GS} = 0V, I _D = 1.0mA
∆BV _{DSS} /∆TJ	Temperature Coefficient of Breakdown Voltage	_	0.29	_	V/°C	Reference to 25°C, ID = 1.0mA
RDS(on)	Static Drain-to-Source On-State Resistance	—	—	0.18	Ω	VGS = 10V, ID = 10.2A $_{\textcircled{4}}$
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
9fs	Forward Transconductance	6.1	—	—	S	V _{DS} > 15V, I _{DS} = 10.2A ④
IDSS	Zero Gate Voltage Drain Current	—	—	25	μA	V _{DS} = 160V ,V _{GS} =0V
		—	—	250	μΑ	VDS = 160V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	—	—	100	nA	$V_{GS} = 20V$
IGSS	Gate-to-Source Leakage Reverse	_	—	-100		VGS = -20V
Qg	Total Gate Charge	_	—	60		VGS =10V, ID = 16A
Qgs	Gate-to-Source Charge	—	—	10.6	nC	$V_{DS} = 100V$
Qgd	Gate-to-Drain ('Miller') Charge	_	—	37.6	l	
^t d(on)	Turn-On Delay Time	—	—	20		V _{DD} = 100V, I _D = 16A,
tr	Rise Time	—	—	152	ns	V_{GS} =10V, R_{G} = 9.1 Ω
^t d(off)	Turn-Off Delay Time	—	—	58	115	
tf	Fall Time	—	—	67		
L _S + L _D	Total Inductance		6.8		nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
C _{iss}	Input Capacitance		1300			$V_{GS} = 0V, V_{DS} = 25V$
C _{oss}	Output Capacitance	_	400		pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	—	130	—		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min	Тур	Мах	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	—	—	16	۸	
ISM	Pulse Source Current (Body Diode) ①	_	_	64	A	
VSD	Diode Forward Voltage		—	1.5	V	$T_j = 25^{\circ}C$, $I_S = 16A$, $V_{GS} = 0V$ (4)
trr	Reverse Recovery Time		_	500	ns	Tj = 25°C, IF = 16A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge	—	—	5.3	μC	$V_{DD} \le 50V $ (4)
ton	Forward Turn-On Time Intrinsic turn-on	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.				

Thermal Resistance

	Parameter	Min	Тур	Мах	Units	Test Conditions
RthJC	Junction-to-Case	—	—	1.25		
RthCS	Case-to-sink	—	0.21	—	°C/W	
R _{th} JA	Junction-to-Ambient	—	—	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website. For footnotes refer to the last page

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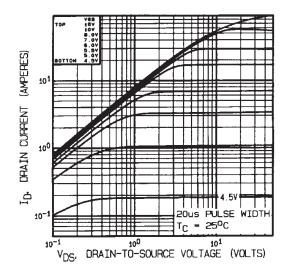


Fig 1. Typical Output Characteristics

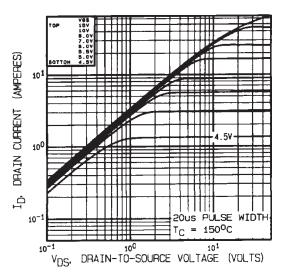


Fig 2. Typical Output Characteristics

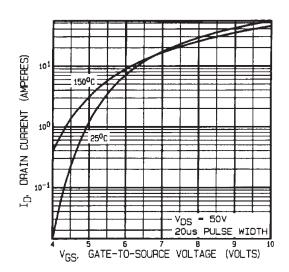


Fig 3. Typical Transfer Characteristics

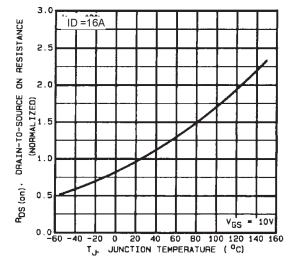


Fig 4. Normalized On-Resistance Vs. Temperature

3

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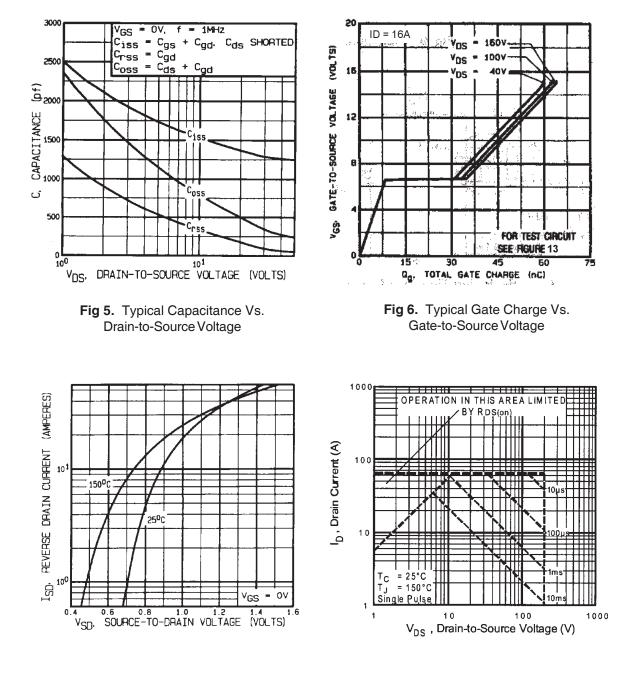
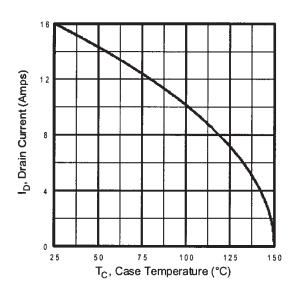


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

IRFY240C, IRFY240CM

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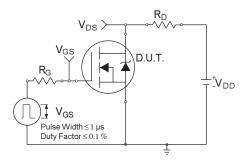


Fig 10a. Switching Time Test Circuit

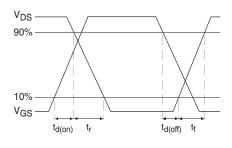


Fig 10b. Switching Time Waveforms

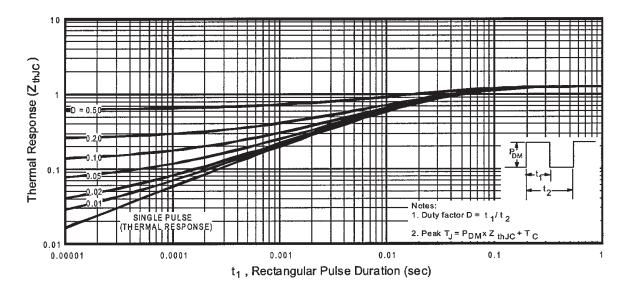


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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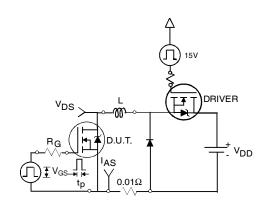


Fig 12a. Unclamped Inductive Test Circuit

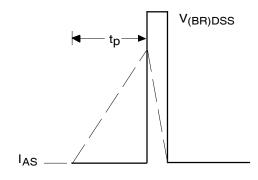


Fig 12b. Unclamped Inductive Waveforms

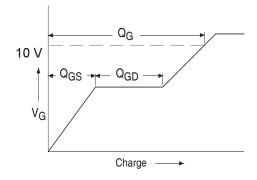


Fig 13a. Basic Gate Charge Waveform

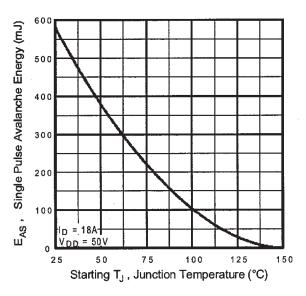


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

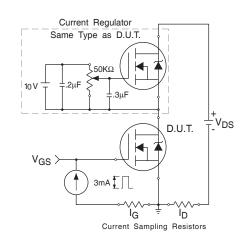


Fig 13b. Gate Charge Test Circuit

IRFY240C, IRFY240CM

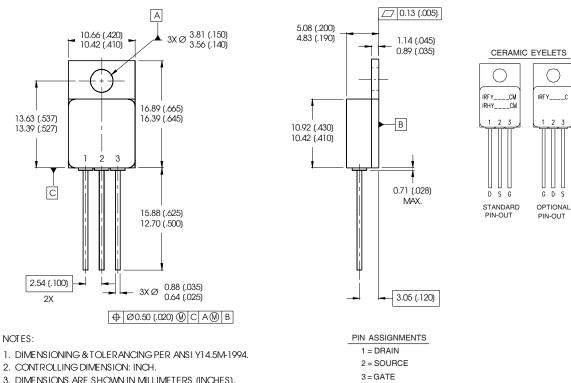
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Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- \odot V_{DD} = 50V, starting T_J = 25°C, L= 4.5mH Peak I_L = 16A, V_{GS} = 10V

Case Outline and Dimensions — TO-257AA

- 3 ISD \leq 16A, di/dt \leq 150A/ μ s, $V_{DD} \le 200V, T_J \le 150^{\circ}C$
- ④ Pulse width \leq 300 μ s; Duty Cycle \leq 2%



3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).

4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA

CAUTION

BERYLLIA WARNING PER MIL-PRF-19500

Package containing beryllia shall not be ground, sandblasted, machined, or have other operations performed on them which will produce beryllia or beryllium dust. Furthermore, beryllium oxide packages shall not be placed in acids that will produce fumes containing beryllium.

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